SN54ABT16952, SN74ABT16952 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

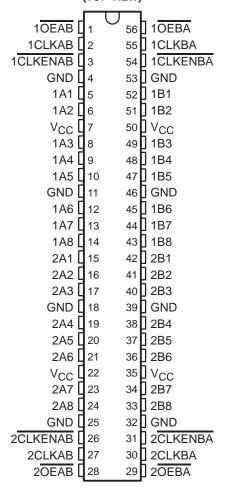
SCBS082C - FEBRUARY 1991 - REVISED JANUARY 1997

- **Members of the Texas Instruments** Widebus™ Family
- State-of-the-Art *EPIC-IIB™* BiCMOS Design Significantly Reduces Power Dissipation
- Latch-Up Performance Exceeds 500 mA Per **JEDEC Standard JESD-17**
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$
- Distributed V_{CC} and GND Pin Configuration **Minimizes High-Speed Switching Noise**
- Flow-Through Architecture Optimizes PCB
- High-Drive Outputs (-32-mA I_{OH}, 64-mA I_{OI})
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic Flat (WD) Package Using 25-mil Center-to-Center Spacings

description

The 'ABT16952 are 16-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. The 'ABT16952 can be used as two 8-bit transceivers or one 16-bit transceiver. Data on the A or B bus is stored in the registers on the low-to-high transition of the clock (CLKAB or CLKBA) input provided that the clock-enable (CLKENAB or CLKENBA) input is low. Taking the output-enable (OEAB or OEBA) input low accesses the data on either port.

SN54ABT16952 . . . WD PACKAGE SN74ABT16952...DGG OR DL PACKAGE (TOP VIEW)



To ensure the high-impedance state during power up or power down, $\overline{\sf OE}$ should be tied to ${\sf V}_{\sf CC}$ through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16952 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16952 is characterized for operation from -40°C to 85°C.



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FUNCTION TABLE†

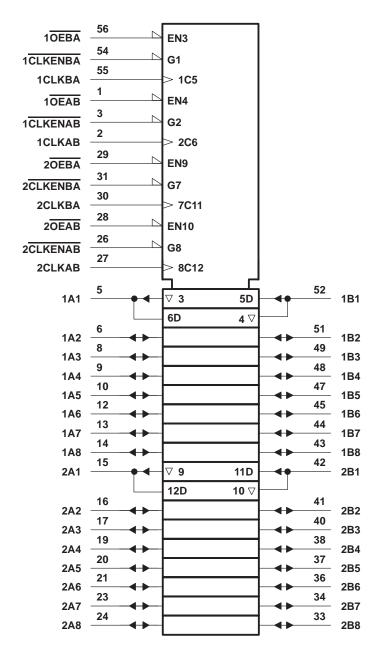
| | ОИТРИТ | | | |
|---------|------------|------|---|--------------------------------------|
| CLKENAB | CLKAB | OEAB | Α | В |
| Н | Х | L | Χ | в ₀ ‡ |
| Х | L | L | Χ | B ₀ ‡ B ₀ ‡ |
| L | \uparrow | L | L | L |
| L | \uparrow | L | Н | н |
| Х | Χ | Н | Χ | Z |

[†] A-to-B data flow is shown; B-to-A data flow is similar, but uses CLKENBA, CLKBA, and OEBA.



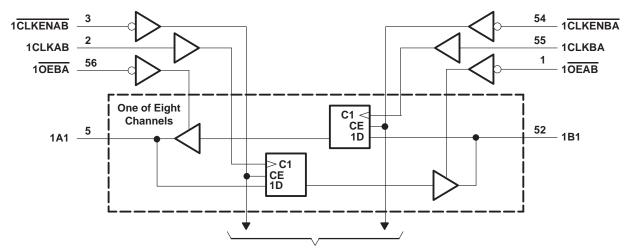
[‡]Level of B before the indicated steady-state input conditions were established

logic symbol†

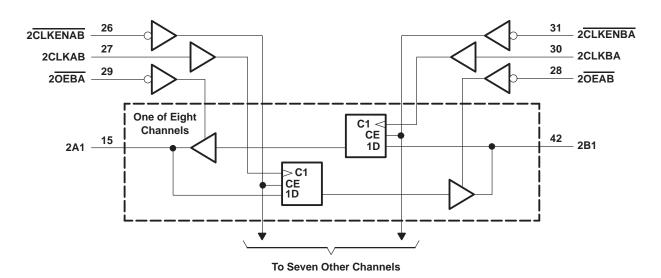


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



To Seven Other Channels



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | -0.5 V to 7 V |
|---|----------------|
| Input voltage range, V _I (except I/O ports) (see Note 1) | |
| Voltage range applied to any output in the high or power-off state, VO | 0.5 V to 5.5 V |
| Current into any output in the low state, I _O : SN54ABT16952 | 96 mA |
| SN74ABT16952 | |
| Input clamp current, I _{IK} (V _I < 0) | –18 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | |
| Package thermal impedance, θ _{JA} (see Note 2): DGG package | 81°C/W |
| DL package | |
| Storage temperature range, T _{stq} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

| | | | SN54ABT | 16952 | SN74AB1 | 16952 | UNIT |
|--|---|-----------------|-------------|-------|---------|-------|------|
| | | | MIN | MAX | MIN | MAX | UNIT |
| V _{CC} Supply voltage | | | | 5.5 | 4.5 | 5.5 | V |
| V _{IH} High-level input voltage | | | | EM | 2 | | V |
| V _{IL} | V _{IL} Low-level input voltage | | | | | 0.8 | V |
| VI | V _I Input voltage | | | | 0 | VCC | V |
| ІОН | IOH High-level output current | | | | | -32 | mA |
| loL | Low-level output current | | 200 | 48 | | 64 | mA |
| Δt/Δν | Input transition rise or fall rate | Outputs enabled | 75 | 10 | | 10 | ns/V |
| TA | Operating free-air temperature | | – 55 | 125 | -40 | 85 | °C |

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with EIA/JEDEC Std JESD51.

SN54ABT16952, SN74ABT16952 16-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS082C - FEBRUARY 1991 - REVISED JANUARY 1997

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| | | TEST CONDITIONS | | Т | A = 25°C | ; | SN54AB | Г16952 | SN74ABT16952 | | UNIT | |
|--------------------|----------------|--|----------------------------------|---------------------------------|----------|-----------------|--------|-----------------|--------------|------|------|--|
| | | TEST CON | TEST CONDITIONS | | TYP | MAX | MIN | MAX | MIN | MAX | UNII | |
| VIK | | $V_{CC} = 4.5 \text{ V},$ | $I_{I} = -18 \text{ mA}$ | | | -1.2 | | -1.2 | | -1.2 | V | |
| | | $V_{CC} = 4.5 \text{ V},$ | $I_{OH} = -3 \text{ mA}$ | 2.5 | | | 2.5 | | 2.5 | | | |
| \/a | | $V_{CC} = 5 V$, | $I_{OH} = -3 \text{ mA}$ | 3 | | | 3 | | 3 | | V | |
| VOH | | V _{CC} = 4.5 V | $I_{OH} = -24 \text{ mA}$ | 2 | | | 2 | | | | v | |
| | | VCC = 4.5 V | $I_{OH} = -32 \text{ mA}$ | 2* | | | | | 2 | | | |
| \/01 | | V _{CC} = 4.5 V | I _{OL} = 48 mA | | | 0.55 | | 0.55 | | | V | |
| VOL | | VCC = 4.5 V | I _{OL} = 64 mA | | | 0.55* | | | | 0.55 | V | |
| V _{hys} | | | | | 100 | | | 2 | | | mV | |
| ١. | Control inputs | V _{CC} = 5.5 V, V _I = V _{CC} or GND | | | | ±1 | | <u>±</u> 1 | | ±1 | μА | |
| l _l | A or B ports | VCC = 5.5 V, | AL = ACC OL GIAD | | | ±100 | | ±100 | | ±100 | μΑ | |
| lozh‡ | | $V_{CC} = 5.5 \text{ V},$ | $V_0 = 2.7 \text{ V}$ | | | 50 | 2 | 50 | | 50 | μΑ | |
| I _{OZL} ‡ | | $V_{CC} = 5.5 \text{ V},$ | V _O = 0.5 V | | | - 50 | 50 | - 50 | | -50 | μΑ | |
| I _{off} | | $V_{CC} = 0$, | V_I or $V_O \le 4.5 \text{ V}$ | | | ±100 | 90 | | | ±100 | μΑ | |
| ICEX | | V _{CC} = 5.5 V, V _O = 5.5 V | Outputs high | | | 50 | Q | 50 | | 50 | μА | |
| I _O § | | V _{CC} = 5.5 V, | V _O = 2.5 V | -50 | -100 | -200 | -50 | -200 | -50 | -200 | mA | |
| | | V _C C = 5.5 V, | Outputs high | | | 2 | | 2 | | 2 | | |
| Icc | A or B ports | $I_O = 0$, | Outputs low | | | 35 | | 35 | | 35 | mA | |
| | | V _I = V _{CC} or GND Outputs disabled | | I = VCC or GND Outputs disabled | | 2 | | 2 | | 2 | | |
| ΔICC¶ | | $V_{CC} = 5.5 \text{ V}$, One in Other inputs at V_{CC} | | | | 0.5 | | 0.5 | | 0.5 | mA | |
| Ci | Control inputs | V _I = 2.5 V or 0.5 V | | | 3 | | | | | | pF | |
| Cio | A or B ports | V _O = 2.5 V or 0.5 V | | | 8.5 | | | | | | pF | |

^{*} On products compliant to MIL-PRF-38535, this parameter does not apply.

[†] All typical values are at $V_{CC} = 5 \text{ V}$.

[‡] The parameters IOZH and IOZL include the input leakage current.

[§] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[¶]This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

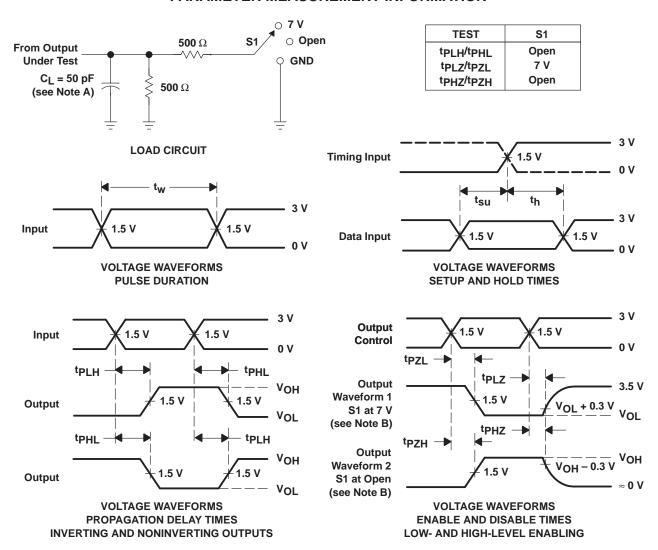
| | | | V _{CC} = | = 5 V, 25°C | SN54AB | Г16952 | SN74AB1 | 16952 | UNIT |
|------------------|--|--------------------|-------------------|----------------|--------|--------|---------|-------|------|
| | | | MIN | MAX | MIN | MAX | MIN | MAX | |
| fclock | Clock frequency | 0 | 150 | 0 | 150 | 0 | 150 | MHz | |
| t _w † | Pulse duration, CLKAB or CLKBA high or low | | | | 3.3 | 7/4 | 3.3 | | ns |
| | Setup time, | A or B | 3.5 | | 3.5 | | 3.5 | | 20 |
| t _{su} | before CLKAB↑ or CLKBA↑ | CLKENAB or CLKENBA | 3 | | 3 | | 3 | | ns |
| Hold time, | Hold time, | A or B | 1 | 01 | | 1 | | | |
| th th | after CLKAB↑ or CLKBA↑ | CLKENAB or CLKENBA | 1 | | Q 1 | | 1 | | ns |

[†] This parameter is warranted, but not production tested.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L = 50 pF (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM TO (INPUT) (OUTPUT) | | V _{CC} = 5 V, T _A = 25°C | | | SN54ABT16952 | | SN74ABT16952 | | UNIT |
|------------------|--------------------------|----------|---|-----|-----|------------------|-----|--------------|-----|------|
| | (INFOT) | (001701) | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f _{max} | | | 150 | | | 150 | N | 150 | | MHz |
| ^t PLH | CLK | A or B | 1 | 2.6 | 3.9 | 1 | 4.4 | 1 | 4.3 | ne |
| ^t PHL | CLK | AOIB | 1 | 2.6 | 4.2 | 1,0 | 4.6 | 1 | 4.5 | ns |
| ^t PZH | ŌĒ | A or B | 1 | 2.5 | 3.8 | 1 | 4.7 | 1 | 4.6 | ns |
| t _{PZL} | OE | AUIB | 1 | 2.8 | 5.1 | 37 | 6.1 | 1 | 6 | 115 |
| ^t PHZ | ŌĒ | A or B | 1.7 | 3.4 | 4.7 | O _{1.7} | 6.1 | 1.7 | 5.5 | 20 |
| t _{PLZ} | OE | AOIB | 1.3 | 3 | 3.9 | 1.3 | 4.8 | 1.3 | 4.2 | ns |

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{Q} = 50 Ω , t_{f} \leq 2.5 ns, t_{f} \leq 2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







.com 5-Sep-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|-------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|------------------------------|
| 74ABT16952DGGRE4 | ACTIVE | TSSOP | DGG | 56 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT16952DGGR | ACTIVE | TSSOP | DGG | 56 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT16952DL | ACTIVE | SSOP | DL | 56 | 20 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT16952DLR | ACTIVE | SSOP | DL | 56 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74ABT16952DLRG4 | ACTIVE | SSOP | DL | 56 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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